# BGA Heat Sink - High Performance maxiFLOW/superGRIP



#### ATS Part#:

Description:

Heat Sink Type: maxiFLOW Heat Sink Attachment: superGRIP Equivalent Part Number: N/A

\*Image above is for illustration purpose only.

### **Features & Benefits**

- Designed for 37.5 x 37.5 mm components
- Requires minimal space around the component's perimeter; ideal for densely populated PCBs
- Allows the heat sink to be detached and reattached without damaging the component or the PCB, an important feature in the event a PCB may need to be reworked

ATS-X50375P-C1-R0

Performance maxiFLOW/superGRIP

37.50 x 37.50 x 17.50 mm BGA Heat Sink - High

- Strong, uniform attachment force helps achieve maximum performance from phase-changing TIMs
- Eliminates the need to drill mounting holes in the PCB

## **Thermal Performance**

		@200 LFM 1.0 M/S	@300 LFM 1.5 M/S	@400 LFM 2.0 M/S	@500 LFM 2.5 M/S	@600 LFM 3.0 M/S	@700 LFM 3.5 M/S	@800 LFM 4.0 M/S
THERMAL RESISTANCE	Unducted Flow	2.1 °C/W	1.7 °C/W	1.5 °C/W	1.3 °C/W	1.2 °C/W	1.1 °C/W	1.1 °C/W
	Ducted Flow	1.6	N/A	N/A	N/A	N/A	N/A	N/A

# **Product Detail**

Schematic Image	Dimension A	Dimension B	Dimension C	Dimension D	ТІМ	Finish
	37.50 mm	37.50 mm	17.50 mm	65.2 mm	T766	BLUE-ANODIZED
Thage above is for illustration purpose only.	<ul> <li>Dimension</li> <li>Thermal papplication</li> <li>ATS resense</li> <li>Performant</li> <li>ATS certification</li> </ul>	performance data are n. rves the right to upda nce. ies that this heat sin	emponent size. leight from the bottor provided for referen ate or change its prov k assembly is RoHS listom options availab	nce only. Actual perfo ducts without notice -6 and REACH comp	ormance to improv	may vary by

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), **sales@qats.com** or **www.qats.com**.

